

# IMAGINATION. CREATION. INNOVATION.

**3DB HYBRID  
COUPLERS**

**ANTENNA SWITCH  
MODULES**

**ATTENUATORS**

**BLUETOOTH  
MODULES**

**CONNECTORS**

**DIRECTIONAL  
COUPLERS**

**HI-Q CAPACITORS**

**INDUCTORS**

**LOW ESR NPO  
CAPACITORS**

**LOW PASS FILTERS**

**MOS CAPACITORS**

**PASSIVE MICRO  
COMPONENTS**

**POWER RF  
CAPACITORS**

**RX MODULES**

**SAW FILTERS**

**SINGLE LAYER  
CAPACITORS**

**TIMING DEVICES**









































**TX MODULES**



## AVX RF/Microwave Short Form

# RF Microwave Products Application Guide

SUNSTAR微波光电 <http://www.rfoc.net/> TEL:0755-83396822 FAX:0755-83376182 E-MAIL:szss20@163.com

APPLICATIONS PRODUCTS	Medical (MRI) Public Safety Radio Marine Radio Power Amplifiers	ISM Radios WLAN (802.XX) Gigabit Ethernet/Optical Power Amplifiers Basestation Amplifiers	Space & Military WLAN (802.XX) Gigabit Ethernet/Optical Power Amplifiers Basestation Amplifiers	Space & Military Gigabit Ethernet/Optical Power Amplifiers
System Frequency	Up to 300MHz	300-3000MHz	3-30GHz	30GHz+
High Directivity Couplers (0402, 0603)				
Couplers (0603, 0805)				
3dB Couplers				
KNA Filter				
Low Pass Filter 0805				
Low Pass Filter 0603				
EMI Miniature Filter				
Inductors (0603,0805)				
LGA Inductors 0402				
Ultra Tight Tolerance RF Capacitors (Accu-P®)				
SQ CS,CA,CB Capacitors				
U Dielectric Capacitors				
HQ CC/CE Capacitors				
HQ L Capacitors				
Single Layer Capacitors (SLC)				
Bordered Single Layer Capacitors				
Multi-Padded Single Layer Capacitors				
Maxi Single Layer Capacitors				
GZ Capacitors				
GZ StackCap				
MOS/MIS Capacitors				
Filters - Passive Micro Components				
Inductors - Passive Micro Components				
Resistors - Passive Micro Components				
Capacitors - Passive Micro Components				
Attenuators				
Bluetooth Module RB06				
Bluetooth Module RB04				
Voltage Controlled Crystal Oscillators				
Antenna Switch Module				
CMOS Clock Oscillators				
Crystal Units				
SMD MHz Resonators				
RF Shield Lock Connector 8069				
MOBO™ Standard I/O with RF Co-ax				
Pogo Pin I/O with RF Co-ax				

SUNSTAR射频通信 <http://www.rfoe.net/> TEL:0755-83397033 FAX:0755-83376182 E-MAIL:szss20@163.com

# RF Microwave Short Form

## Table of Contents

### Couplers, Filters, Inductors, Capacitors

High Directivity Couplers (0402, 0603) . . . . .	2
Directional Couplers (0603, 0805) . . . . .	2
3dB Couplers . . . . .	2
EMI Filter – KNA Series . . . . .	3
Low Pass Filter 0805 . . . . .	3
Low Pass Filter 0603 . . . . .	3
EMI Miniature Filters . . . . .	4
Inductors (0603, 0805) . . . . .	4
LGA Inductors (0402) . . . . .	5
Ultra Tight Tolerance RF Capacitors (Accu-P®) . . . . .	5
SQCS, SQCA & SQCB . . . . .	6
U Dielectric . . . . .	6
HQCC & HQCE . . . . .	7
HQLC & HQLE . . . . .	7
Single Layer Capacitors (SLC) – GH Series . . . . .	8
Bordered Single Layer Capacitors – GB Series . . . . .	8
Multi-Padded Single Layer Capacitors . . . . .	9
Maxi/Maxi+ Single Layer Capacitors . . . . .	9
GZ Surface Mount SLC . . . . .	10
GZ StackCap . . . . .	10

### PMC (Passive Micro Components)

#### Resistors, Capacitors & Inductors

##### Discrete, Array or RCL Filters

MOS/MIS Capacitors . . . . .	12
RCLs/Filters – Passive Micro Components . . . . .	12
Inductors – Passive Micro Components . . . . .	13
Resistors – Passive Micro Components . . . . .	13
Capacitors – Passive Micro Components . . . . .	14
Resistors Material Selection . . . . .	14
Capacitor Material Details . . . . .	14

### Modules & Timing Devices

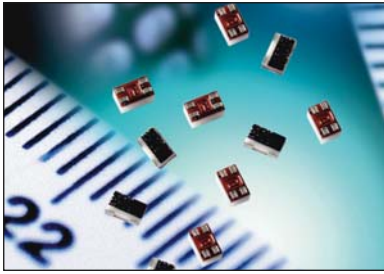
Chip Attenuators ATC1A Series . . . . .	16
Bluetooth Module – RB06 Series . . . . .	16
Bluetooth Module – RB04 Series . . . . .	16
Voltage Controlled Crystal Oscillators	
VC-TCXO-208C / KT18B, VC-TCXO-214C / KT21 Series . . . . .	17
Antenna Switch Module LM/LX Series . . . . .	17
CMOS Clock Oscillator – MFO-208F Series . . . . .	17
Crystal Units CX-3225SB (CX-101F), CX-2520SB, CX5032SB (CX-96F) . . . . .	18
SMD Resonators PBRC-MR Series . . . . .	18
Resonator Cross-Reference Table . . . . .	18

### Connectors

RF Shield Lock Connector 8069 . . . . .	20
MOBO™ Standard I/O with RF Co-ax . . . . .	20
Pogo Pin I/O with RF Co-ax . . . . .	20



# High Directivity Couplers (0402, 0603)

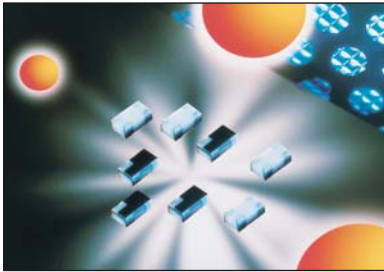


- High Directivity
- Low Parasitics
- 4 Terminal
- 3 Watts Continuous
- Low Profile

## HOW TO ORDER

<b>CP</b>   <b>Style</b> Directional Coupler	<b>0603</b>   <b>Size</b> 0402 0603	<b>X</b>   <b>Type</b>	<b>****</b>   <b>Frequency</b> MHz	<b>X</b>   <b>Sub Type</b>	<b>L</b>   <b>Termination Code</b> L = LGA Sn90, Pb10 N = LGA Sn100	<b>TR</b>   <b>Packaging Code</b> TR = Tape and Reel
---	---	------------------------------	---	----------------------------------	---	---

# Directional Couplers (0603, 0805)



- 50 ohm Impedance
- Lead Free
- 800 MHz to 6 GHz
- 3 Watts Continuous
- Low Profile

## HOW TO ORDER

<b>CP</b>   <b>Style</b> Directional Coupler	<b>0603</b>   <b>Size</b> 0603 0805	<b>X</b>   <b>Type</b>	<b>****</b>   <b>Frequency</b> MHz	<b>X</b>   <b>Sub Type</b>	<b>W</b>   <b>Termination Code</b> W = Sn90, Pb10 S = Sn100	<b>TR</b>   <b>Packaging Code</b> TR = Tape and Reel
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# 3dB Couplers



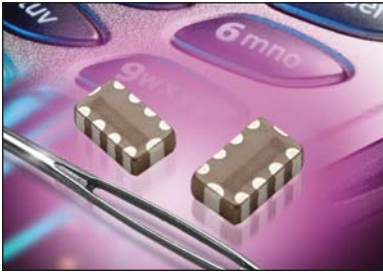
- 0805 Size
- 10 Watts Continuous
- 4 Terminal
- Low Insertion Loss
- High Isolation

## HOW TO ORDER

<b>DB</b>   <b>Style</b>	<b>0805</b>   <b>Size</b>	<b>A</b>   <b>Type</b>	<b>****</b>   <b>Frequency</b> MHz	<b>A</b>   <b>Sub Type</b>	<b>W</b>   <b>Termination Code</b> W = Sn90, Pb10 S = Sn100	<b>TR</b>   <b>Packaging Code</b> TR = Tape and Reel
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# EMI Filter – KNA Series



- Distributed constant type LC Filter
- Prevents Ringing caused by Circuit Impedance
- Suitable for High Speed Digital Circuits and Video Signal Lines
- Stable Noise Attenuation over Wide Frequency Ranges
- Small, Low Profile SMT Package

## HOW TO ORDER

**KNA**  
Series

**21**  
Size  
EIA = 0805  
EIAJ = 2012

**400**  
Frequency  
400 = 400MHz  
\*Frequency at Attenuation  
typical 3dB, max 6dB

**W**  
Taping Direction  
W = Standard

**3**  
Quantity per Reel  
3 = 3000 pieces

# Low Pass Filter 0805



- 50 ohm Impedance
- 3 Watts Continuous
- Low Profile
- 800 MHz to 3.5 GHz
- 4 Terminal

## HOW TO ORDER

**LP**  
Style  
Low Pass

**0805A**  
Size  
0805

**0902**  
Frequency  
MHz

**AW**  
Termination  
Nickel/Solder (Sn/Pb)

**TR**  
Packaging Code  
TR = Tape and Reel

# Low Pass Filter 0603



- 50 ohm Impedance
- 3 Watts Continuous
- Low Profile
- Lead Free
- Low Parasitics

## HOW TO ORDER

**LP**  
Style

**0603**  
Size  
0603

**A**  
Type

**XXXX**  
Frequency  
MHz

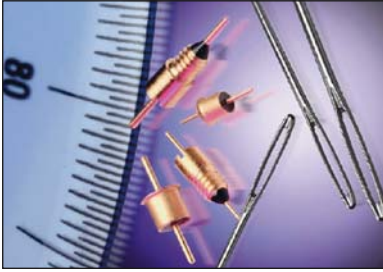
**A**  
Sub Type

**N**  
Termination  
LGA  
Ni/Lead Free Solder

**TR**  
Tape & Reel



# EMI Miniature Filters

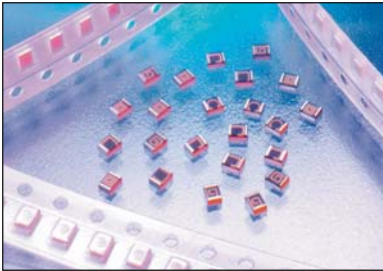


- World's smallest filters 73mm diameter
- Available in screw-in and solder-in style
- Superior insertion loss up to 10GHz
- Available in "L", "C", or "T" circuit
- Rugged discoidal capacitor design

## HOW TO ORDER

<b>ZXS</b> ↓	<b>2</b> ↓	<b>C</b> ↓	<b>3</b> ↓	<b>-</b> ↓	<b>1 0 3</b> └──┬──┘ ↓
<b>Basic Style</b>	<b>Circuit</b>	<b>Voltage</b>	<b>Lead</b>	<b>Reliability Code</b>	<b>3-Digit Capacitor Code</b> (In pF)
ZX5 ZYS ZXS SXD SYD SZD	1 = Feed Thru 2 = L-Section 4 = T-Section	A = 100 VDC B = 200 VDC C = 50 VDC	3 = Special	- = Standard R = R-Level B = Class "B" S = Class "S"	

# Inductors (0603, 0805)

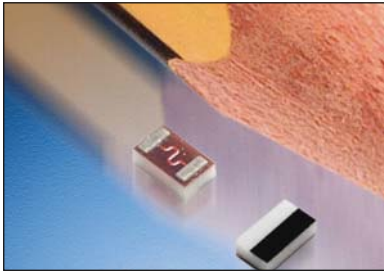


- Tight Tolerance
- Hi-Q
- High Self Resonance
- High RF Power Capability
- Low DC Resistance

## HOW TO ORDER

<b>L</b> ↓	<b>0805</b> └──┬──┘ ↓	<b>4R7</b> └──┬──┘ ↓	<b>D</b> ↓	<b>E</b> ↓	<b>W</b> ↓	<b>TR</b> ↓
<b>Product</b> Inductor	<b>Size</b> 0603 0805	<b>Inductance</b> Expressed in nH (2 significant digits + number of zeros) <b>for</b> <b>values &lt;10nH,</b> letter R denotes decimal point. Example: 22nH = 220 4.7nH = 4R7	<b>Tolerance for</b> <b>L ≤ 4.7nH,</b> B = ±0.1nH C = ±0.2nH D = ±0.5nH <b>4.7nH &lt; L &lt; 10nH,</b> C = ±0.2nH D = ±0.5nH <b>L ≥ 10nH,</b> G = ±2% J = ±5%	<b>Specification Code</b> E = Accu-L® 0805 technology G = Accu-L® 0603 technology	<b>Termination Code</b> W = Nickel/ solder coated (Sn63, Pb37)	<b>Packaging Code</b> TR = Tape and Reel (3,000/reel)

# LGA Inductors (0402)



- Inherent Low Profile
- Low Parasitics
- Tight Tolerance
- Better Heat Dissipation
- Low Profile

## HOW TO ORDER

**L**  
Inductor

**0402**  
Size  
0402  
0603

**XXX**  
Inductance  
(nH)

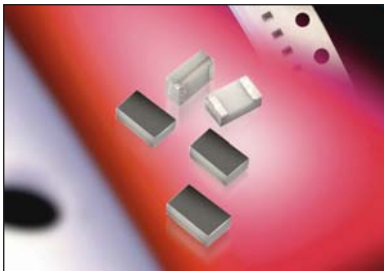
**X**  
Tolerance  
A =  $\pm 0.05$ nH  
B =  $\pm 0.1$ nH  
C =  $\pm 0.2$ nH  
D =  $\pm 0.5$ nH

**H**  
Series  
F =  $\pm 1\%$   
G =  $\pm 2\%$   
J =  $\pm 5\%$

**L**  
LGA  
Termination

**TR**  
Tape & Reel

# Ultra Tight Tolerance RF Capacitors (Accu-P®)



- Tight Tolerance
- No secondary resonances
- Repeatable lot to lot
- 0201-1210 size
- Low ESR

## HOW TO ORDER

**0805**

**5**

**J**

**Size**  
0201  
0402  
0603  
0805  
1210

**Voltage**  
1 = 100V  
5 = 50V  
3 = 25V  
Y = 16V  
Z = 10V

**Temperature Coefficient (1)**  
J =  $0 \pm 30$ ppm/°C  
(-55°C to +125°C)  
K =  $0 \pm 60$ ppm/°C  
(-55°C to +125°C)

**120**

**Capacitance**  
Capacitance expressed in pF. (2 significant digits + number of zeros)  
**for values <10pF,**  
letter R denotes decimal point.  
Example:  
68pF = 680  
8.2pF = 8R2

**G**

**Tolerance for C $\leq$ 2.0pF\***  
P =  $\pm 0.02$ pF  
Q =  $\pm 0.03$ pF  
A =  $\pm 0.05$ pF  
B =  $\pm 0.1$ pF  
C =  $\pm 0.25$ pF  
**for C $\leq$ 3.0pF**  
Q, A, B, C  
**for C $\leq$ 5.6pF**  
A, B, C  
**for 5.6pF < C < 10pF**  
B, C, D  
**for C $\geq$ 10pF**  
F =  $\pm 1\%$   
G =  $\pm 2\%$   
J =  $\pm 5\%$

**B**

**Specification Code**  
B = Accu-P® technology

**W**

**Termination Code**  
W = Nickel/Solder Coated  
**Accu-P® 0201 & 0402**  
Sn90, Pb10  
T = Nickel/High Temperature Solder Coated  
**Accu-P® 0603, 0805, 1210**  
Sn96, Ag4  
S = Nickel/Lead Free Solder Coated  
**Accu-P® 0402**  
Sn100

**TR**

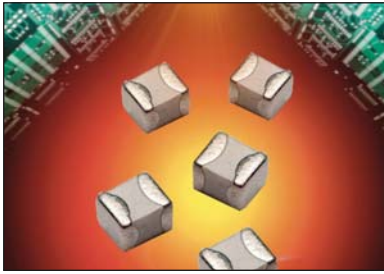
**Packaging Code**  
TR = Tape and Reel

(1) TC's shown are per EIA/IEC Specifications.

\* Tolerances as tight as  $\pm 0.01$ pF are available. Please consult the factory.



# SQCS, SQCA & SQCB



- High Self Resonance
- WVDC to 500 VDC
- Low ESR
- Hi-Rel versions available
- Lead Free available

## HOW TO ORDER

<b>SQ</b>	<b>CB</b>	<b>7</b>	<b>M</b>	<b>100</b>	<b>J</b>	<b>A</b>	<b>1</b>	<b>ME</b>
<b>AVX Style</b> SQ	<b>Case Size</b> CS = 0603 CA = 0605 CB = 1210	<b>Voltage Code</b> 5 = 50V 1 = 100V E = 150V 2 = 200V V = 250V 9 = 300V 7 = 500V	<b>Temperature Coefficient Code</b> M = +90±20ppm/°C A = 0±30ppm/°C C = 15% ("J" Termination only)	<b>Capacitance</b> EIA Capacitance Code in pF. First two digits = significant figures or "R" for decimal place. Third digit = number of zeros or after "R" significant figures.	<b>Capacitance Tolerance Code</b> A = ±.05 pF B = ±.1 pF C = ±.25 pF D = ±.5 pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% N = ±30%	<b>Failure Rate Code</b> A = Not Applicable	<b>Termination Style Code</b> 1 = Pd/Ag 7 = Ag/Ni/Au J = Nickel Barrier Sn/Pb (60/40) T = 100% Tin	<b>Packaging Code</b> ME = 7" Reel RE = 13" Reel WE = Waffle Pack 3A = SQCS 13" 6A = SQCS Waffle Pack 1A = SQCS 7"

## U Dielectric



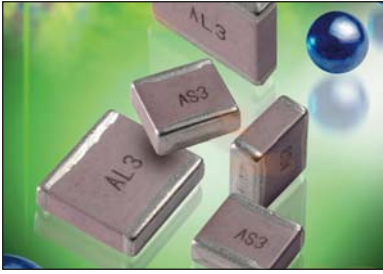
- Low ESR
- High Q
- Low Cost
- High Self Resonance
- 0402-1210 sizes

## HOW TO ORDER

<b>0805</b>	<b>1</b>	<b>U</b>	<b>100</b>	<b>J</b>	<b>A</b>	<b>T</b>	<b>2</b>	<b>A</b>
<b>Case Size</b> 0402 0603 0805 1210	<b>Voltage Code</b> 3 = 25V 5 = 50V 1 = 100V 2 = 200V	<b>Dielectric = Ultra Low ESR</b>	<b>Capacitance</b> EIA Capacitance Code in pF. First two digits = significant figures or "R" for decimal place. Third digit = number of zeros or after "R" significant figures.	<b>Capacitance Tolerance Code</b> B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	<b>Failure Rate Code</b> A = Not Applicable	<b>Termination</b> T = Plated Ni and Tin	<b>Packaging Code</b> 2 = 7" Reel 4 = 13" Reel 9 = Bulk	<b>Special Code</b> A = Standard



# HQCC & HQCE

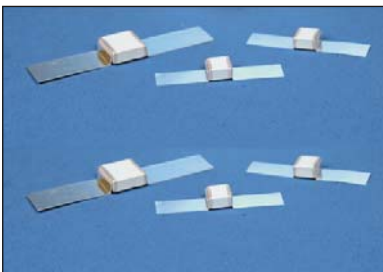


- 600 to 4,000 VDC
- High Current capable
- Low ESR
- Non-Magnetic Versions
- Leaded versions available

## HOW TO ORDER

<u>HQCC</u>	<u>A</u>	<u>A</u>	<u>271</u>	<u>J</u>	<u>A</u>	<u>T</u>	<u>1</u>	<u>A</u>
<b>AVX Style</b> HQCC HQCE	<b>Voltage</b> 600V = C 1000V = A 1500V = S 2000V = G 2500V = W 3000V = H 4000V = J	<b>Temperature Coefficient</b> COG = A	<b>Capacitance Code</b> (2 significant digits + no. of zeros) Examples: 4.7 pF = 4R7 10 pF = 100 100 pF = 101 1,000 pF = 102	<b>Capacitance Tolerance</b> C = $\pm 0.25\text{pF}$ (<13pF) D = $\pm 0.50\text{pF}$ (<25pF) F = $\pm 1\%$ ( $\geq 25\text{pF}$ ) G = $\pm 2\%$ ( $\geq 13\text{pF}$ ) J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$	<b>Test Level</b> A = Standard	<b>Termination</b> 1 = Pd/Ag T = Plated Ni and Sn (RoHS Compliant) J = 5% Min Pb	<b>Packaging</b> 1 = 7" Reel 3 = 13" Reel 9 = Bulk	<b>Special Code</b> A = Standard

# HQLC & HQL



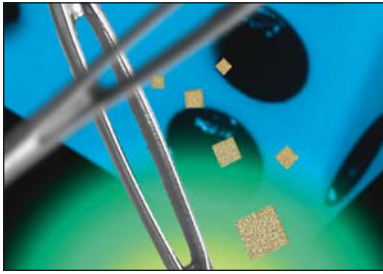
- 600 to 4,000 VDC
- High Current capable
- Low ESR
- Non-Magnetic Versions
- Leaded versions available

## HOW TO ORDER

<u>HQLC</u>	<u>A</u>	<u>A</u>	<u>271</u>	<u>J</u>	<u>A</u>	<u>A</u>
<b>AVX Style</b> HQLC HQL	<b>Voltage</b> 600V = C 1000V = A 1500V = S 2000V = G 2500V = W 3000V = H 4000V = J	<b>Temperature Coefficient</b> COG = A	<b>Capacitance Code</b> (2 significant digits + no. of zeros) Examples: 4.7 pF = 4R7 10 pF = 100 100 pF = 101 1,000 pF = 102	<b>Capacitance Tolerance</b> C = $\pm 0.25\text{pF}$ (<13pF) D = $\pm 0.50\text{pF}$ (<25pF) F = $\pm 1\%$ ( $\geq 25\text{pF}$ ) G = $\pm 2\%$ ( $\geq 13\text{pF}$ ) J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$	<b>Test Level</b> A = Standard	<b>Lead Style</b> A = Axial Ribbon M = Microstrip



# Single Layer Capacitors (SLC) – GH Series

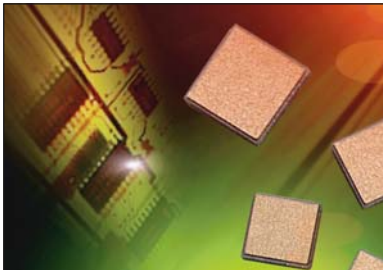


- Dielectrics - NPO thru X7R
- High Q
- Voltage Ratings to 200 VDC
- High Wirebond Strength
- Decoupling/Bypass Applications

## HOW TO ORDER

<b>GH</b> ┆	<b>35</b> ┆	<b>5</b> ┆	<b>A</b> ┆	<b>6R8</b> ┆	<b>K</b> ┆	<b>A</b> ┆	<b>6N</b> ┆
<b>Type Code</b> GH = No Borders	<b>Case Code</b>	<b>Working Voltage Code</b> 5 = 50WVDC 1 = 1000WVDC	<b>Dielectric Code</b> A = NPO 4 = TC 7 = TC Y = TC C = X7R	<b>Capacitance Value</b> EIA Cap Code in pF First two digits = significant figures or "R" for decimal place. Third digit = number of zeros or after "R" significant figures.	<b>Capacitance Tolerance</b> <10pF A = ±0.05pF (Special order) B = ±0.1pF C = ±0.25pF D = ±0.5pF >10pF J = ±5% K = ±10% M = ±20%	<b>Termination Code</b> A = Au (100 μ-in min) over Ti/W (1000 Å nom) also available N = Ti/W-Ni-Au	<b>Packaging Code</b> 6N = Antistatic Waffle Pack

# Bordered Single Layer Capacitors – GB Series

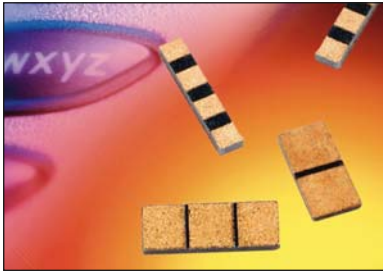


- Minimizes Epoxy Shorting
- Enhances Vision Recognition
- Excellent Wirebonding
- Multiple Dielectrics including Maxi & Maxi+
- Decoupling/Bypass Applications

## HOW TO ORDER

<b>GB</b> ┆	<b>35</b> ┆	<b>5</b> ┆	<b>A</b> ┆	<b>6R8</b> ┆	<b>K</b> ┆	<b>A</b> ┆	<b>6N</b> ┆
<b>Type Code</b> GB = With Borders	<b>Case Code</b>	<b>Working Voltage Code</b> 5 = 50WVDC 1 = 1000WVDC	<b>Dielectric Code</b> A = NPO 4 = TC 7 = TC Y = TC C = X7R	<b>Capacitance Value</b> EIA Cap Code in pF First two digits = significant figures or "R" for decimal place. Third digit = number of zeros or after "R" significant figures.	<b>Capacitance Tolerance</b> <10pF A = ±0.05pF (Special order) B = ±0.1pF C = ±0.25pF D = ±0.5pF >10pF J = ±5% K = ±10% M = ±20%	<b>Termination Code</b> A = Au (100 μ-in min) over Ti/W (1000 Å nom) also available N = Ti/W-Ni-Au	<b>Packaging Code</b> 6N = Antistatic Waffle Pack

# Multi-Padded Single Layer Capacitors

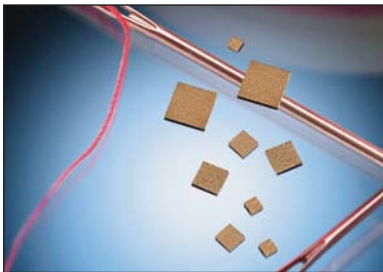


- Maximizes Board Space Efficiency
- Reduces Part Handling
- Excellent Wirebonding
- Multiple Dielectrics including Maxi/Maxi+
- Custom Configurations Available

## HOW TO ORDER

<b>GH</b> ┆	<b>B</b> ┆	<b>5</b> ┆	<b>5</b> ┆	<b>8</b> ┆	<b>102</b> ┆	<b>P</b> ┆	<b>A</b> ┆	<b>6N</b> ┆
<b>Type Code</b>	<b>Array Code</b>	<b>Size Code</b>	<b>Working Voltage Code</b>	<b>Dielectric Code</b>	<b>Cap Code</b>	<b>Cap Tolerance</b>	<b>Termination Code</b>	<b>Packaging Code</b>
	B = 2 C = 3 D = 4 E = 5 F = 6	2 = .020" W Y = .025" W 3 = .030" W 4 = .040" W 5 = .050" W S = Special	5 = 50VDC	A = NP0 C = X7R Z = X7S 8 = Maxi 9 = Maxi+	EIA Cap Code in pF	P = +100% -0% Z = +80% -20%  Dual-Caps M = ±20% available	A = Au (100 μ-in min) over Ti/W (1000 Å nom) also available N = Ti/W-Ni-Au	6N = Antistatic Waffle Pack

# Maxi/Maxi+ Single Layer Capacitors



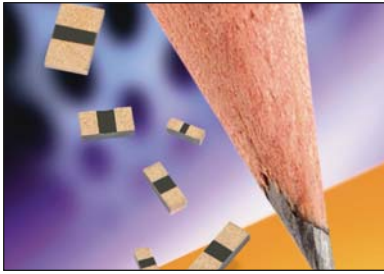
- 20K & 30K Dielectric Constants
- Industry Leading Volumetric Efficiency
- X7R Temperature Characteristics
- Excellent for RF Bypass Applications
- High Bond Strength

## HOW TO ORDER

<b>GH</b> ┆	<b>02</b> ┆	<b>5</b> ┆	<b>8</b> ┆	<b>102</b> ┆	<b>M</b> ┆	<b>A</b> ┆	<b>6N</b> ┆
<b>Type Code</b>	<b>Case Size</b>	<b>Working Voltage Code</b>	<b>Dielectric Code</b>	<b>Capacitance Value</b>	<b>Capacitance Tolerance</b>	<b>Termination Code</b>	<b>Packaging Code</b>
GH = No Borders GB = With Borders	01 02 03 04 05 06	5 = 50 VDC	8 = Maxi (k = 20,000) 9 = Maxi+ (k = 30,000)	EIA Cap Code in pF	K = ±10% M = ±20% Z = +80% -20%	A = Au (100 μ-in min) over Ti/W (1000 Å nom) also available N = Ti/W-Ni-Au	6N = Antistatic Waffle Pack



# GZ Surface Mount SLC



- Performance thru 40 GHz
- Surface Mount Configuration
- 6 Standard Footprints - 0415 thru 0805
- Compatible with All Standard Soldering Processes
- Custom Designs Available

## HOW TO ORDER

<b>GZ</b>   Style	<b>0402</b>   Mounting Footprint	<b>5</b>   Voltage Rating 5 = 50V	<b>800</b>   Capacitance EIA Cap Code in pF	<b>Z</b>   Capacitance Tolerance Z = +80%, 20%	<b>N</b>   Termination (Sputtered) TiW-Ni-Au	<b>W</b>   Packaging Code Waffle Pack
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# GZ StackCap



- DC Blocking to 40 GHz
- High Temp SLC/MLC Joint
- 0415, 0402 & 0602 Footprints
- No Solder Embrittlement Issues
- Custom Designs Available

## HOW TO ORDER

<b>GZ</b>   Style	<b>0402</b>   Mounting Footprint	<b>Z</b>   Voltage Rating Z = 10V Y = 16V 3 = 25V	<b>D</b>   MLC Dielectric X7R = C X5R = D	<b>104</b>   MLC Capacitance EIA Cap Code in pF	<b>M</b>   MLC Tolerance M = ±20%	<b>800</b>   SLC Capacitance EIA Cap Code in pF	<b>Z</b>   SLC Tolerance Z = +80% -20%	<b>N</b>   SLC Termination Ti/W-Ni-Au	<b>T or W</b>   Packaging Code T = Tape & 7" Reel W = Waffle Pack
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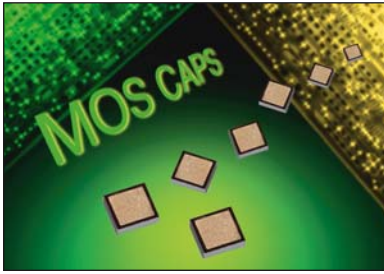


# PMC (PASSIVE MICRO COMPONENTS) RESISTORS, CAPACITORS & INDUCTORS DISCRETE, ARRAY OR RCL FILTERS

## Typical R, C, L Materials & Designs Offered

Passive	Resistors		Capacitors				Inductor
<b>Material</b>	TaN	SiCr	SiON	SiO <sub>2</sub>	BCB	X7R	Cu
<b>Minimum Chip Size (mm)</b>	0.5x0.5	0.5x0.5	0.25x0.25	0.25x0.25	0.5x0.5	0.5x0.5	1.0x0.5
<b>Range</b>	0.47-1M Ohm	47R-20M Ohm	1-500pF	1-500pF	1-50pF	2.2pF-400nF	0.5-20nH
<b>Trimable</b>	Yes	Yes	Yes	No	Yes	No	No
<b>Tolerance</b> <b>NOTE value dependent</b>	0.05%	0.05%	≥ 0.5%; or ≥ 0.05pF	≥ 0.5%; or ≥ 0.05pF	≥ 0.5%; or ≥ 0.05pF	5%	5%
<b>Performance</b> <b>NOTE TCR, in ppm/°C</b>	TCR -100 to -150	TCR ±25; ±250	K 5.8 TCC 60	K 4 TCC 30	K 2.7 TCC 42	K 1000	Q ≤ 80
<b>I/O Type</b>	BGA (Ball Grid Array), LGA (Land Grid Array), and gold or aluminum wire bond						

# MOS/MIS Capacitors

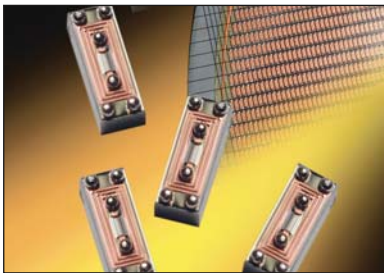


- GHz operation
- Ultra stable capacitance through time and with temperature
- Custom specification welcome, arrays or binary
- Size down to 10x10 mils
- SiO<sub>2</sub> and SiON Dielectrics

## HOW TO ORDER

MS	20	3	S	100	M	3893	W
<b>Series Code</b> MS = MOS MI = MIS	<b>Case Size</b> Square Size in mils 10, 20, 30, 40 OS = Special Order Please supply design	<b>Working Voltage</b> 2 = 2V 4 = 4V Z = 10V 3 = 25V 5 = 50V 1 = 100V	<b>Dielectric Code</b> S = SiO <sub>2</sub> For MOS Style ONLY N = SiON For MIS Style ONLY	<b>Capacitance</b> EIA Capacitance Code in pF First two digits = significant figures or R for decimal place Third digit = number of zeros or after "R" significant figures	<b>Capacitance Tolerance</b> F = ±1% (MOS only) J = ±5% (MOS only) K = ±10% M = ±20%	<b>Termination Code</b> 1st position top layer 2nd position top bonding layer 3rd position bottom bonding layer 4th position bottom layer 1=Al, 2=Cr, 3=Au, 4=Ni, 5=Pd, 6=Ta, 7=TaN, 8=TiW, 9=TiWNi OSOS=Special Order Please Supply Design	<b>Packaging</b> W = Antistatic Waffle Pack T = Tested, Whole Wafer D = Tested. Diced Wafer on Tape

# RCLs/Filters – Passive Micro Components

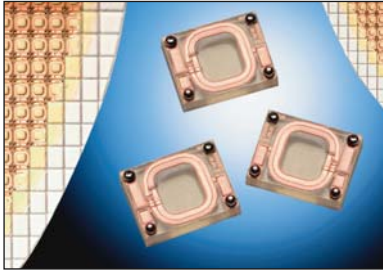


- Trimmable capacitors and resistors for superior performance
- Bring us your analog RCL designs
- BGA, LGA, wire bondable terminations
- Silicon, glass or quartz substrates
- RF blocking, DC bias filters

## HOW TO ORDER

N	2	2	2	5	B	2	A	C	E	G	1	2A
<b>Integrated Passive Thin Film</b>	<b>Number of Resistors</b>	<b>Number of Capacitors</b>	<b>Number of Inductors</b>	<b>Rated Voltage</b>	<b>Wafer Substrate</b>	<b>Resistor Material</b>	<b>Capacitor Material</b>	<b>Inductor Material</b>	<b>Special Features</b>	<b>Failure Rate</b>	<b>Termination Type</b>	<b>Packaging</b>
	0-9 a = 10 b = 11 c = 12 etc.	0-9 a = 10 b = 11 c = 12 etc.	0-9 a = 10 b = 11 c = 12 etc.	2 = 2V 4 = 4V Z = 10V 3 = 25V 5 = 50V	A = Glass B = Silicon C = Quartz S = Special	1 = SiCr 2 = TaN X = NA	A = NPO C = X7R X = NA	C = Copper X = NA	A = Al wire pad E = Eutectic F = Fiducial G = Au wire pad H = High Temp Solder U = Lead Free	A = Standard G = Medical	1 = BGA 2 = Flip Clip 3 = Wire Bond 4 = LGA "Land Grid Array"	2A = 7" Reel 6A = Waffle Pack T = Tested, whole wafer D = Tested, diced wafer on tape

# Inductors – Passive Micro Components

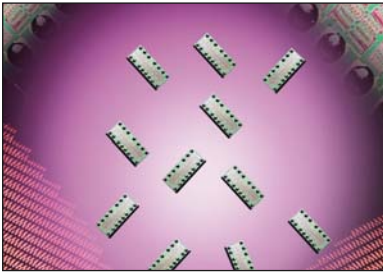


- Up to 40nH or Q of 80
- Low profile multiturn designs
- BGA, LGA, wire bondable terminations
- Glass substrates for improved performance
- Thick precision plated copper layers

## HOW TO ORDER

N	X	X	2	L	B	X	X	C	E	G	1	2A
↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑
<b>Integrated Passive Thin Film</b>	<b>Number of Resistors</b> X = NA	<b>Number of Capacitors</b> X = NA	<b>Number of Inductors</b> 0-9 a = 10 b = 11 c = 12 etc.	<b>Rated Voltage</b> L = Current and Frequency Dependent	<b>Wafer Substrate</b> A = Glass B = Silicon C = Quartz S = Special	<b>Resistor Material</b> X = NA	<b>Capacitor Material</b> X = NA	<b>Inductor Material</b> C = Copper	<b>Special Features</b> A = Al wire pad E = Eutectic F = Fiducial G = Au wire pad H = High Temp Solder U = Lead Free	<b>Failure Rate</b> A = Standard G = Medical	<b>Termination Type</b> 1 = BGA 2 = Flip Clip 3 = Wire Bond 4 = LGA "Land Grid Array"	<b>Packaging</b> 2A = 7" Reel 6A = Waffle Pack T = Tested, whole wafer D = Tested, diced wafer on tape

# Resistors – Passive Micro Components



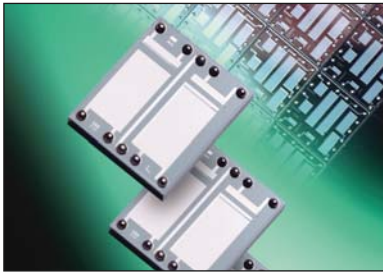
- High Ohmic SiCr and TaN materials
- Laser trimmable designs, matched arrays and networks
- BGA, LGA, wire bondable terminations
- Silicon, glass or quartz substrates
- High voltage designs up to 1000 volts

## HOW TO ORDER

N	2	X	X	R	B	2	X	X	E	G	1	2A
↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑	↑
<b>Integrated Passive Thin Film</b>	<b>Number of Resistors</b> 0-9 a = 10 b = 11 c = 12 etc.	<b>Number of Capacitors</b> X = NA	<b>Number of Inductors</b> X = NA	<b>Rated Voltage</b> R = Power Dependent	<b>Wafer Substrate</b> A = Glass B = Silicon C = Quartz S = Special	<b>Resistor Material</b> 1 = SiCr 2 = TaN	<b>Capacitor Material</b> X = NA	<b>Inductor Material</b> X = NA	<b>Special Features</b> A = Al wire pad E = Eutectic F = Fiducial G = Au wire pad H = High Temp Solder U = Lead Free	<b>Failure Rate</b> A = Standard G = Medical	<b>Termination Type</b> 1 = BGA 2 = Flip Clip 3 = Wire Bond 4 = LGA "Land Grid Array"	<b>Packaging</b> 2A = 7" Reel 6A = Waffle Pack T = Tested, whole wafer D = Tested, diced wafer on tape



# Capacitors – Passive Micro Components

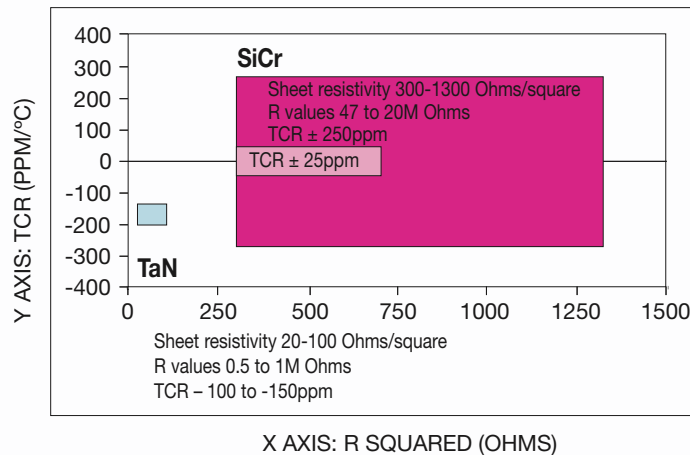


- Precision tolerances, 0.5% capacitance, 0.05% tracking available
- NP0 materials suitable for GHz applications
- BGA, LGA, wire bondable terminations
- Complex matched arrays and networks welcome
- Silicon, glass or quartz substrates
- Stability,  $\pm 30$ , 42, or 60 ppm/ $^{\circ}\text{C}$

## HOW TO ORDER

N	X	2	X	Z	B	X	A	X	E	G	1	2A
<b>Integrated Passive Thin Film</b>	<b>Number of Resistors</b>	<b>Number of Capacitors</b>	<b>Number of Inductors</b>	<b>Rated Voltage</b>	<b>Wafer Substrate</b>	<b>Resistor Material</b>	<b>Capacitor Material</b>	<b>Inductor Material</b>	<b>Special Features</b>	<b>Failure Rate</b>	<b>Termination Type</b>	<b>Packaging</b>
	X = NA	0-9 a = 10 b = 11 c = 12 etc.	X = NA	2 = 2V 4 = 4V Z = 10V 3 = 25V 5 = 50V 1 = 100V	A = Glass B = Silicon C = Quartz S = Special	X = NA	A = NP0 C = X7R	X = NA	A = Al wire pad E = Eutectic F = Fiducial G = Au wire pad H = High Temp Solder U = Lead Free	A = Standard G = Medical	1 = BGA 2 = Flip Clip 3 = Wire Bond 4 = LGA "Land Grid Array"	2A = 7" Reel 6A = Waffle Pack T = Tested, whole wafer D = Tested, diced wafer on tape

## Resistors Material Selection



## Capacitor Material Details

Material	X7R	SiON	SiO <sub>2</sub>	BCB
<b>pF / mm<sup>2</sup> Typical</b>	8000 @ 5V, up to 25000 @ 3V*	55	35	25
<b>Stability</b>	-55 to +125 $\pm 15\%$	$\pm 60$ ppm/ $^{\circ}\text{C}$	$\pm 30$ ppm/ $^{\circ}\text{C}$	$\pm 42$ ppm/ $^{\circ}\text{C}$
<b>Rated Voltage</b>	3 - 5	$\leq 100$	$\leq 100$	$\leq 25$
<b>BDV (V/<math>\mu\text{m}</math>)</b>	100	600	1000	300
<b>DF</b>	$\leq 8\%$	$\leq 0.1\%$	$\leq 0.1\%$	$\leq 0.1\%$
<b>Voltage Stability</b>	Less 1.25% per volt from 0 to 5 volts	Independent	Independent	Independent
<b>Frequency Range</b>	$\leq 10$ GHz	$\leq 40$ GHz	$\leq 40$ GHz	$\leq 75$ GHz

\*Based on dielectric thickness of 0.25 $\mu\text{m}$  @ 3V, and 0.5 $\mu\text{m}$  @5V





# MODULES & TIMING DEVICES

# Chip Attenuators ATC1A Series



- Attenuation: 1 ~ 10dB
- 50 ohm Impedance
- Reduction in Mounting and Process Costs
- Saves PCB Space
- RoHS Compliant

## HOW TO ORDER

**ATC**

Series

**1A**

Size

1A = 1.0x1.0mm

**2**

Attenuation

(1 digit numbering)

1 = 1dB    6 = 6dB  
 2 = 2dB    7 = 7dB  
 3 = 3dB    8 = 8dB  
 4 = 4dB    9 = 9dB  
 5 = 5dB    A = 10dB

**C**

Attenuation  
Tolerance

C = ±0.3dB  
 D = ±0.5dB

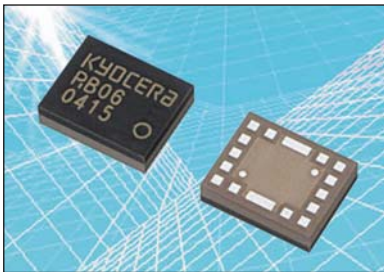
**H**

Packaging

H = Taping Paper  
 10,000pcs/reel  
 \*2mm pitch taping

Available  
in Asia from KED  
(Kyocera Electronic Devices)

# Bluetooth Module – RB06 Series



- Best Solution for CDMA cell phones
- Miniature Size – 5.0 x 4.0 x 1.4mm
- Improved Reception Sensitivity
- Low Power Consumption
- Wide Operating Temperature Range -30 to +75°C

## HOW TO ORDER

All part numbers are customer specific.

Available  
in Asia from KED  
(Kyocera Electronic Devices)

# Bluetooth Module – RB04 Series



- Bluetooth Host Control Interface
- Chip Set: Bluecore3-ROM CSP
- Improved High Sensitivity – -80dBm (typ.) Low Current Consumption – 35mA (typ.)
- Ultra Miniature Size – 5.0 x 4.0 x 1.4mm
- Wide Operating Temperature Range – -40 ~ +85°C  
Power Class 2, RoHS Compliant

## HOW TO ORDER

All part numbers are customer specific.

Available  
in Asia from KED  
(Kyocera Electronic Devices)

# Voltage Controlled Crystal Oscillators

## VC-TCXO-208C / KT18B, VC-TCXO-214C / KT21 Series



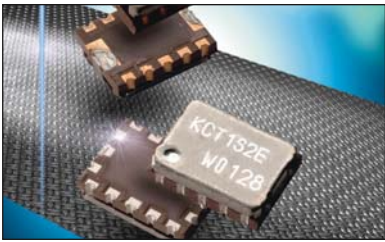
- Designed for use in Cellular Phones and Automotive Applications
- SMT Ceramic Package for Auto Pick-and-Place
- Reflow Soldering Compatible
- Low Power Consumption
- Lead Free

Available  
in Asia from KED  
(Kyocera Electronic Devices)

### HOW TO ORDER

<b>KT18</b>	<b>D</b>	<b>C</b>	<b>V</b>	<b>30</b>	<input type="checkbox"/>	<b>19.680M</b>	<b>T</b>
Series	Frequency Stability	Lower Operating Temperature	Upper Operating Temperature	Supply Voltage	Option Code	Frequency (MHz)	Packaging
KT18 KT21	K = ±5ppm E = ±2.5ppm D = ±2.0ppm	C = -30°C E = -20°C G = -10°C	W = +85°C V = +80°C U = +75°C	28 = 2.8V 30 = 3.0V		12,600 16,800 19,800 13,000 19,200 26,000 14,400 19,440 38,400 19,680	Tape & Reel KT18 = 4000pcs/Reel KT21 = 2000pcs/Reel

# Antenna Switch Module LM/LX Series



- Supports multiple Bands – GSM/DCS/PCS
- Dual / Triple / Quad Bands
- Small Size / Low Profile
- Low Current Consumption
- Includes ESD Protection

### HOW TO ORDER

<b>LX</b>	<b>Q</b>	<b>6</b>	<b>15</b>	<b>SX</b>	<b>E</b>
Series	Circuit	Type	Height	Custom Specification	ESD Protection
LM = Dual LM = Triple LX = Quad	Q = Quad T = Triple D = Dual	1 5 6	15 = 1.5mm max 18 = 1.8mm max		

Available  
in Asia from KED  
(Kyocera Electronic Devices)

# CMOS Clock Oscillator – MFO-208F Series



- “H” type Designed Ceramic SMT Package
- Reflow Solder Compatible
- High Reliability Seam Welding
- Tri-state Function
- CMOS Output
- ±15 PPM / -40 ~ +85°C available

Available  
in Asia from KED  
(Kyocera Electronic Devices)

### HOW TO ORDER

<b>KT5032N</b>	<b>26000</b>	<b>D</b>	<b>C</b>	<b>W</b>	<b>28</b>	<b>T</b>	<b>AA</b>
Series	Output Frequency	Frequency Tolerance	Lower Operating Temperature	Upper Operating Temperature	Supply Voltage	Voltage Control Range	Option Code
		B = ±1.0x10 <sup>-6</sup> C = ±1.5x10 <sup>-6</sup> D = ±2.0x10 <sup>-6</sup>	C = -30°C E = -20°C G = -10°C	W = +85°C V = +80°C U = +75°C	28 = 2.8V 30 = 3.0V	TCXO = T VCTCXO = Customer Spec	



# Crystal Units CX-3225SB (CX-101F), CX-2520SB, CX5032SB (CX-96F)



- For Audio and Visual Office Equipment and Mobile Communications
- Reference Frequency for Telecommunication Systems
- Small and Low Profile Ceramic Package
- Lead Free Product
- Reflow Solder Compatible

Available  
in Asia from KED  
(Kyocera Electronic Devices)

**CX-2520SB**  
2.5 x 2.0mm  
26-60 kHz

**CX-3225SB**  
3.2 x 2.5mm  
12-54 kHz

**CX-5032SB**  
5.0 x 3.2mm  
9.8-120 MHz

## SMD Resonators PBRC-MR Series



- SMT Package – 4.5 x 2.0 mm
- Frequency Range – 2.00 ~ 20.00 MHz
- Initial Frequency Tolerance – 0.3%, 0.5% or 0.7%
- Automotive Grade Available
- RoHS Compliant

Available  
in Asia from KED  
(Kyocera Electronic Devices)

### HOW TO ORDER

<b>PBRC</b>	<b>15</b>	<b>H</b>	<b>R</b>	<b>10</b>	<b>Y</b>	<b>0AB</b>
<b>Series</b> PBRC: Consumer	<b>Frequency</b> (MHz)	<b>Type</b> H & M	<b>Packing</b> Bulk (Null) R = Reel	<b>Frequency Tolerance at 25°C</b> 10 = ±0.1% 20 = ±0.2% 30 = ±0.3% 40 = ±0.4% 50 = ±0.5% 70 = ±0.7%	<b>Operating Temperature</b> X = -40/85°C Y = -40/125°C Z = -40/150°C	<b>Unique Code</b>

## Resonator Cross-Reference Table

AVX		MURATA		TDK		Panasonic	
Part Number	Range	Part Number	Range	Part Number	Range	Part Number	Range
PBRC-GR (AR)	3.58-20.00	CSAC_MGCM	1.80-13.00	CCR_MX7	16.93-50.00	EFOP	2.00-13.00
PBRC-HR (BR)	3.58-20.00	CSTCC_MG	2.00-10.00	CCR_MXC7	16.93-50.00	EFOS	2.00-13.00
PBRV-HR-Y	3.58-20.00	CSTCC_MG_A	2.00-10.00				
PBRC-LR	4.00-20.00						
PBRC-MR	4.00-20.00	CSTCR_MG	4.00-7.99				
PBRV-MR-Y	4.00-20.00	CSTCR_MG_A	4.00-7.99				
SSR-B	20.00-60.00						
SSR-D	20.00-60.00	CSTCW_MX	20.00-70.00				

All information in this cross reference guide, should be checked by the customer for suitability of our products for their applications. AVX shall have no liability for the accuracy of the information contained within this cross reference.





**AVX**  
**CONNECTORS**

## Connectors – 8069 Series & 0.5mm/0.4mm Pitch Board to Board



- Designed for RF Shielding
- 1.8mm and 3.0mm heights available
- Applicable to 0.2mm shield case thickness
- Two locking point secure holding feature
- Easy Shield Case removal

### HOW TO ORDER

<b>04</b>	<b>8069</b>	<b>000</b>	<b>X00</b>	<b>800</b>
Tape & Reel	Series Number		Variation Code	Plating Code

## MOBO™ Standard I/O with RF Co-ax



- Combination signal and RF format
- SMT receptacle and cabled plug
- 10k mating cycles
- Vertical SMT cradle connector
- Robust, keyed connector system

### HOW TO ORDER

<b>10</b>	<b>9157</b>	<b>015</b>	<b>000</b>	<b>001</b>
10 = Plug 20 = Socket	Series	Number of Positions	Coax Option	Termination

## Pogo Pin I/O with RF Co-ax



- Compression RF contact design
- Integrated into Pogo-Pin connector body
- Custom capabilities
- Robust/Industrial design
- 30,000 mating cycles

### HOW TO ORDER

<b>58</b>	<b>9151</b>	<b>012</b>	<b>000</b>	<b>001</b>
00 = Standard 58 = Special	Series	Number of Positions	Not Assigned	Variation Code

If you have any questions about our RF/Microwave products, please e-mail us at [avxrf@avxus.com](mailto:avxrf@avxus.com)

For the very latest innovations in RF/Microwave products from AVX, visit us on the web at:

[www.avxrf.com](http://www.avxrf.com)

**Contact:**

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传真：0755-83376182 (0) 13902971329 MSN: [SUNS888@hotmail.com](mailto:SUNS888@hotmail.com)

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上海分公司：上海市北京东路 668 号上海赛格电子市场 D125 号

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西安分公司：西安高新开发区 20 所(中国电子科技集团导航技术研究所)

西安劳动南路 88 号电子商城二楼 D23 号

TEL: 029-81022619 13072977981 FAX: 029-88789382